Solution based CVD of main group materials

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This critical review focuses on the solution based chemical vapour deposition (CVD) of main group materials with particular emphasis on their current and potential applications. Deposition of thin films of main group materials, such as metal oxides, sulfides and arsenides, have been researched owing to the array of applications which utilise them including solar cells, transparent conducting oxides (TCOs) and window coatings. Solution based CVD processes, such as aerosol-assisted (AA)CVD have been developed due to their scalability and to overcome the requirement of suitably volatile precursors as the technique relies on the solubility rather than volatility of precursors which vastly extends the range of potentially applicable compounds. An introduction into the applications and precursor requirements of main group materials will be presented first followed by a detailed discussion of their deposition reviewed according to this application. The challenges and prospects for further enabling research in terms of emerging main group materials will be discussed.

1 Introduction

Thin films incorporating main group elements play a critical role in many current and potential applications. This is particularly true for electronic applications with semiconductors based on combinations of elements from Groups III and V, III and VI, II and VI and IV and VI having significant impact on our every day lives.

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There is an increasing demand for new materials and cost-effective methods of depositing these materials while minimising environmental impact, to align with the current rapid growth of these industries.

These materials are currently used in the form of thin films and a variety of methods have been employed to deposit these films including chemical vapour deposition (CVD), atomic layer deposition (ALD), spin coating and sol–gel methods. The most common method to thin films is CVD, which can be used to deposit on small scale coatings, such as microelectronics and larger areas of growth, for example glass/steel coatings.\textsuperscript{1} Due to a large variety of variables and different types of CVD, the properties of the thin films can be fine-tuned and good film uniformity and compositional control is possible. However, both the composition and structure of the deposited materials can be significantly affected by the nature and purity of the precursors. Generally, it is important to have volatile precursors for use in CVD and the reaction chemistry can be complex. Aerosol-assisted (AA)CVD is a solution-based process, which relies on the solubility rather than volatility, of the precursor.\textsuperscript{2} In the AACVD process, precursors are dissolved in a solvent from which an aerosol is generated via the use of an ultrasonic humidifier/nebulizer, which creates a ‘precursor mist’, which can then be transported to the CVD reactor by a carrier gas. The transport of aerosol droplets, rather than relying on the evaporation of volatile precursors in order to transport precursors to the reaction chamber, is a key advantage of AACVD. The process is scalable, allows for the formation of multicomponent materials and the simplification of the precursor delivery stage potentially reduces the cost of the deposition process. The particle size and morphology of the deposited film can be closely controlled by the deposition temperature, choice of solvent and controlling the frequency of the ultrasonic modulator. As such CVD has been used in the production of nanomaterials with tailored features.\textsuperscript{3–5} The formation of thin films via AACVD is the result of homogeneous or heterogeneous reaction or a combination of both homogeneous nucleation in the gas phase and heterogeneous growth on the substrates.

This review examines the use of AACVD as a method for the deposition of thin films of main group materials. The influence of precursors utilised and deposition conditions employed on film characteristics is discussed and applications to which AACVD has been found beneficial will be highlighted. This review aims to summarise recent achievements of AACVD in the preparation of these main group materials, and to present some ideas regarding future prospects. The review is organised to provide an overview of the deposition of thin films of main group materials, grouped according to their application. The importance of morphological control, from the selection of precursors used to deposition conditions chosen is key for best performance in the targeted technological applications; which are discussed in the order: main group semiconductors, TCOs, PEC materials and gas sensors.

2 Overview of precursor requirements

In order to limit potential contamination in deposited thin films a crucial requirement for a precursor is its purity. Hence, development of precursors requires investigation into purification techniques and potentially alternative synthetic routes to achieve highly pure compounds. For scale up and use in industry, the precursor must be able to be prepared and isolated readily in large quantities, and with minimal environmental or cost implications. Stability and low toxicity of the precursor are also important for ease of use and storage.

CVD processes traditionally involved the use of dual source precursors but efforts to lower the growth temperature resulted in the development of single-source precursors, which already contain an M–E bond (e.g. M = group 12, 13, 14 element; E = N, P, As, Sb, S, Se etc.) at the core of the molecule, with various other ligands attached to each of the elements. The desired reaction pathway involves adsorption of the precursor without breaking the M–E bond but with loss of the ancillary ligands. Single-source precursors potentially display a range of advantages over conventional CVD precursors, including:

- Limited pre-reaction as there is only one precursor.
- Reduced toxicity (e.g. for III–V materials AsH₃, PH₃ are eliminated from the CVD process).
- Possible lower temperature growth.
- Air and moisture stability is possible.

However, commercialisation of single-source precursors are still limited due to their disadvantages, including:

- Difficulties in control of stoichiometry using single-source precursors, such as in the growth of ternary and quaternary materials, for example In₃Ga₁₋ₓAsₓ.
- Low volatility, such that the use of established MOCVD equipment is difficult.

- Low surface mobility of polynuclear decomposition fragments can prevent epitaxial growth.

During CVD, it is necessary for the precursor to decompose at elevated temperatures on the surface of a substrate, such as glass, to result in deposition of the required thin film. Typically, therefore, volatility is very important such that the precursor will be readily volatile at temperatures below its decomposition to yield high quality thin films. The development of solution based CVD routes has meant that the requirement of volatility of precursors has been overcome as these techniques rely on solubility of the precursor rather than volatility. This vastly extends the range of potentially applicable compounds for use as precursors to thin films. AACVD is a solution based technique that has generated much interest in the deposition of a wide range of films. In the AACVD process a nebulizer is used to form aerosol droplets of the precursor solution to transport precursors to the reaction chamber using a carrier gas (Fig. 1). On reaching the substrate, evaporation of the solvent occurs due to the increase in temperature. Hence, the vapourised precursor is then in its gaseous state and deposition onto the substrate can occur to yield the desired material. An advantage of AACVD is that the requirement to isolate and purify a precursor, as required in conventional CVD processes, is not always necessary and the precursor can be synthesised \textit{in situ} in the solution being used in the AACVD process. Furthermore, simply mixing different precursors in the solution used within the AACVD process has enabled deposition of ternary materials. Therefore, AACVD has
eliminated many of the disadvantages traditionally associated with single-source precursors (volatility, control of stoichiometry). The conditions applied during deposition in an AACVD process can greatly affect the microstructure of the film with the morphology of the deposited films depending on a range of factors, including temperature, solvent, substrate and the precursor.

3 Main group semiconductors

Informative reviews of the growth techniques and structural, electrical and optical properties as well as applications of semiconductors have been published by Malik et al., Ambacher, Strite et al., and Jones and O’Brien. Applications of semiconductors include in solar cells, light emitting diodes, photocathodes, lasers and thermal imaging devices. Volatile organometallic compounds have been increasingly used for the deposition of compound semiconductors. Metalorganic chemical vapour deposition (MOCVD) is commonly used for the formation of semiconductors using organometallic precursors. This process either uses a dual- or single-source precursor system. The progress of techniques of this type has been the result of developments in precursor chemistry including improved synthesis and purification. One of the driving forces in recent years in the organometallic chemistry of group 13 (Al, Ga, In) has been their increased use in the electronics industry, for example semiconducting III–V materials such as GaAs, GaN and InP. Other semiconductors formed using organometallic precursors include chalcogenides (SnS, In₂S₃), and ternary compounds (CuInSe₂). In this section the development of precursors for compound semiconductors for use in AACVD is described.

3.1 Groups 12 and 16 (II–VI) thin films

The intermediate energy band gaps of II–VI semiconductors has led to their use in a variety of devices. For example, cadmium chalcogenides have applications in solid-state solar cells, ion-light emitting diodes for flat-panel displays, sensors and in field-effect transistors. The Zn- and Cd-based chalcogenides (ZnS, ZnSe, CdS, CdSe and CdTe) have been grown by conventional MOCVD from dimethyl-cadmium or -zinc in combination with H₂S, H₂Se or Me₂Te and from single-source precursors. Low temperature growth is important because these II–VI materials interdiffuse and form defects at temperatures above 500 °C. To reduce toxicity and the growth temperature and control the purity of the films deposited new precursors have been developed. For example, mixed alkyl/dithio- or diseleno-carbamates and xanthanates are potential precursors to II–VI materials as they provide access to lower deposition temperatures and zinc selenide, cadmium sulfide and cadmium selenide thin films have been deposited from compounds, of the type [RM(E₂CNMe₂)]₂ (M = Zn, Cd, E = S, Se, R = Me, CH₃CMe₃) via MOCVD. Reviews by Gilez and O’Brien provide detailed accounts on the use of other single-source precursors for the deposition of chalcogenide materials by MOCVD. Complexes of this type were expected to be relatively unstable and have low volatility. However, a wide range of compounds have been used in AACVD processes to produce II–VI thin films. Thin films of these materials have also been deposited by other solution based methods such as spray pyrolysis, spin coating, electrostatic assisted aerosol jet deposition, chemical bath deposition and solution growth.

AACVD of CdS, ZnS and Cd₁₋ₓZnₓS films was originally reported by Hampden-Smith et al. utilising precursors, of the type [M(SOCPMe₂)₂(tmeda)] where tmeda = N,N,N,N-tetramethyl-ethylenediamine. AACVD was the chosen CVD technique to aid with the delivery of precursors with lower volatility and ease of handling of highly reactive precursors. The zinc compound, [Zn(SOCPMe₂)₂(tmeda)] was prepared via reaction of ZnEt₂ with two equivalents of HSOCMe and 1 equivalent of tmeda, whereas the Cd species was isolated from the reaction of Cd(CO₃)₂ with HSOCMe and one equivalent of tmeda. The compounds were found to be monomeric and isostructural in the solid state with both possessing S-bonded thioacetate ligands. The coordination environment of the metal atoms in both compounds was a distorted tetrahedral comprising two nitrogen atoms and two sulfur atoms. Decomposition of the compounds was observed to proceed via thermally induced thioacetic anhydride elimination, as shown in eqn (1).

\[ \text{M(SOCMe)₂(tmeda)} \rightarrow \text{MS + S(OCPMe)₂ + tmeda} \] (1)

Precursors, [Zn(SOCPMe₂)₂(tmeda)] and [Cd(SOCPMe₂)₂(tmeda)] were used individually to deposit ZnS and CdS films via AACVD from toluene solutions at 100–250 °C. AACVD of Cd₁₋ₓZnₓS films at 175 °C was also investigated from mixtures of [Cd(SOCPMe₂)₂(tmeda)] and [Zn(SOCPMe₂)₂(tmeda)] in various Cd : Zn ratios of 6 : 4, 5 : 5, 4 : 6 and 2.5 : 7.5. The deposited films were found to have similar growth rates and morphologies as the individual ZnS and CdS films and adopted a (002)-oriented hexagonal phase. Binary phases of ZnS and CdS were not observed by X-ray diffraction but a general trend was found where the films were Cd deficient compared to the solutions by 5–10 at%.

More recently, thin films of CdS, ZnS and Cd₁₋ₓZnₓS have been deposited by AACVD using thio- and dithio-biuret zinc and cadmium precursors, of the type [M(SCNR₂)₂(N)]₂ (M = Zn, Cd, R = Me, Et) and [M(SON(CNPR₂)₂)]₂ (M = Zn, Cd). The ligands and precursors were synthesised as shown in Scheme 1. Reaction of sodium thioyanate, N,N-dialkylcarbamyl chloride and the relevant dialkyamine produced the 1,1,5,5-tetraalkyl-2-thiobiuret ligand. The metal complexes were formed by...
addition of the corresponding metal acetate in methanol to the ligand. A similar synthetic route was followed to isolate dithio-biuret complexes starting from \(N,N'\)-dialkylthiocarbamylchloride. Single crystal X-ray diffraction showed that the zinc or cadmium atom in the precursor adopted a distorted tetrahedral geometry. Thermogravimetric analysis (TGA) indicated that the zinc and cadmium precursors decomposed to the corresponding metal sulfides at similar temperatures. AACVD of \([\text{Zn\{SCNR}_2\text{N}\}_2]\) \((R = \text{Me, Et})\) and \([\text{Zn\{SON(CN}_{iPr}2\}_2]\) in THF allowed the deposition of cubic \(\text{Cd}_2\text{S}_3\) films with small rods and granular crystallites at 300 and 350 °C but hexagonal \(\text{ZnS}\) with granular crystallites at 400 and 450 °C. Likewise, the corresponding cadmium precursors resulted in the deposition of hexagonal granular \(\text{CdS}\) films at all deposition temperatures. By varying the molar ratio of \(\text{Zn:Cd}\) compounds in the precursor mixture, ternary films of \(\text{Cd}_{\text{x}}\text{Zn}_{(1-\text{x})}\text{S}\) were deposited at 400 °C. The formation of a solid solution was confirmed by powder X-ray diffraction (XRD), energy dispersive X-ray (EDAX) spectroscopy and UV-vis. The optical band gap for the \(\text{ZnS}\) films was found to be 3.35 eV, for \(\text{CdS} 2.39\) eV and for \(\text{ZnS}\) a value of 3.10–2.52 eV depending on the value of \(x (x = 0.25, 0.50, 0.75)\). In general, the band gap was found to increase with increasing temperature, as expected. Overall, pairs of precursors resulted in the deposition of homogeneous \(\text{Cd}_{\text{x}}\text{Zn}_{(1-\text{x})}\text{S}\) films, which is largely the result of the zinc and cadmium precursors decomposing at similar temperature in a single step. Thio- and dithio-biurets have also been explored for the synthesis of other metal complexes and deposition of materials including \(\text{Co, Ni, Fe, In, and Cu}\). 20,31

A cadmium complex of dimorpholinodithioacetylacetonate (msacmsac) has been used as a single-source precursor for the deposition of \(\text{CdS}\) films by AACVD. 32 The ligand msacmsac was prepared by the reaction of morpholine with sulfur and allyl propyl ether at 110 °C for several hours. Subsequent reaction of the ligand with cadmium nitrate resulted in the isolation of the cadmium complex, \([\text{Cd(msacmsac)}_{2}\text{(NO}_3\text{)}_2]\). The structure of the complex shows a bidentate coordination by the sulfur atoms of each ligand to the cadmium metal and an overall octahedral coordination geometry, as shown in Fig. 2. AACVD of \([\text{Cd(msacmsac)}_{2}\text{(NO}_3\text{)}_2]\) in dimethylformamide and chloroform (1:1) was carried out at 450 and 500 °C. As expected, thicker films were deposited at the higher temperature and powder XRD indicated that hexagonal \(\text{CdS}\) had been deposited.

Dithiocarbamates are chelating ligands that form stable complexes with most elements. 33,34 As mentioned above, a number of dithiocarbamate precursors have been used for the deposition of metal chalcogenide thin films via MOCVD. 11 In addition, several adducts of cadmium dithiocarbamate complexes were reported but their capabilities as precursors for CVD were not described. 35,36 The formation of adducts was investigated in order to produce precursor molecules with adequate volatility since the addition of a Lewis base decreases the degree of association present in a polymeric structure by forming monomeric complexes. However, they have also been found to meet all the necessary requirements of a precursor for the fabrication of thin films by AACVD. The cadmium dithiocarbamate complex, \([\text{Cd(S}_2\text{CNCy}_2\text{py)}\text{(Cy = cyclohexyl, py = pyridine)}]\) has been used to deposit \(\text{CdS}\) nanostructured thin films on soda and FTO conducting glass substrates by AACVD in toluene, THF and pyridine solutions at 350–450 °C. 37 The complex, \([\text{Cd(S}_2\text{CNCy}_2\text{py)}\text{(Cy = cyclohexyl, py = pyridine)}]\) was shown by single crystal X-ray diffraction to be monomeric with a distorted square pyramidal geometry around the Cd atom. The formation of hexagonal \(\text{CdS}\) thin films resulted from all depositions using \([\text{Cd(S}_2\text{CNCy}_2\text{py)}\text{(Cy = cyclohexyl, py = pyridine)}]\) regardless of the solvent or temperature employed. Thin films of \(\text{CdS}\) with a variety of morphologies and particle sizes could be formed depending on the temperature and also solvent used since the physical properties of the solvent (e.g. boiling point, viscosity, coordination ability etc.) has a marked effect. This is illustrated in Fig. 3 which shows the varied morphology obtained from THF solutions at the various temperatures. For all solvents (pyridine, THF and toluene) selective nanostructures, such as shown in Fig. 3a, were only produced on the conducting FTO substrate and not soda lime. This is a result of the charged aerosol droplets undergoing evaporation causing the electric charge density to increase with the shrinking of the droplet. 18 Due to intense repulsion by the conducting substrate multiple fine particles are selectively formed and absorbed on the substrate where the growing process yields the nanostructures.
AACVD of the related zinc complexes, [Zn(S₂CN(Cy₂)₂)₂] and [Zn(S₂CN(CH₂Ph)Me)₂] in toluene at 375, 425 and 475 °C, has also been reported. In general, ZnS crystallises into two structural polymorphs, cubic (wurtzite) and hexagonal (wurtzite), and phase selectivity is influenced by the precursor, deposition technique, substrate and processing parameters. Using these precursors in AACVD it was found that at the lower deposition technique, substrate and processing parameters. (wurtzite), and phase selectivity is influenced by the precursor, two structural polymorphs, cubic (sphalerite) and hexagonal deposition temperature. For example, using [Zn(S₂CN(Cy₂)₂)₂] the surface morphology of the ZnS films deposited was strongly dependent on the nature of the precursor as well as the deposition temperature. For example, using [Zn(S₂CN(Cy₂)₂)₂] films deposited at 375 °C consisted of well-orientated cauliflower-like structures, whereas unstructured particles were formed from [Zn(S₂CN(CH₂Ph)Me)₂] at the same temperature. The band gaps of the films deposited at 475 °C from [Zn(S₂CN(Cy₂)₂)₂] and [Zn(S₂CN(CH₂Ph)Me)₂] were 3.36 and 3.40 eV, respectively corresponding well with that expected for hexagonal ZnS.

Recently, the pyridine adduct of bis(piperidine dithiocarbamato)cadmium(ii), [Cd(S₂CNC₄H₈)₂(py)] was evaluated as a single-source precursor for the deposition of CdS films. AACVD of [Cd(S₂CNC₄H₈)₂(py)] in chloroform at 350–450 °C deposited thin films of hexagonal CdS with band gaps of ~2.6 eV. Again the temperature of deposition was found to affect the resulting morphology of the film, as shown in Fig. 4. At the lower temperature of 350 °C the CdS films had regular hexagonal-like domains whereas at 450 °C close to spherical granules were observed. The deposition temperature was observed to modify the grain sizes as well as the surface roughness. These precursors were also used to synthesise CdS nanoparticles. Thin films of ZnS and CdS have also been deposited from [M(S₂CNBu₃)₂] (M = Zn, Cd) via AACVD in toluene at 350–450 °C on soda glass substrates. For ZnS, no deposition was observed at 350 °C but at higher temperatures hexagonal ZnS was deposited with a rod-like structure. Thin films of hexagonal CdS could be deposited at 350 °C, which consisted of densely packed granular crystallites whereas at higher temperatures the morphology changes to a flake-like structure.

AACVD of CdS and CdTe has been carried out using [Cd(SP₃Pr₂)₂N₂] and [Cd(TeP₁Pr₂)₂N₂] in toluene at substrate temperatures between 550–550 °C and 375–475 °C, respectively. AACVD of [Cd(SP₃Pr₂)₂N₂] resulted in the formation of hexagonal CdS at deposition temperatures of 500 °C but growth of cubic Cd₆P₇ and orthorhombic Cd₆P₁₀ at 525 °C. SEM of the CdS films grown at 500 °C showed that they were composed of dense, ribbon-like primary crystallites. Synthesis of the CdTe precursor, [Cd{(TeP₁Pr₂)₂N₂}], could not be achieved by direct reaction of NH(P₁Pr₂)₂ with tellurium. An alternative approach involved metalation of NH(P₁Pr₂)₂ with NaH prior to reaction with tellurium, which facilitated the formation of Na[N(TePiPr₂)₂] which was then reacted with CdCl₂. AACVD of [Cd{(TeP₁Pr₂)₂N₂}] resulted in the formation of a mixture of cubic CdTe and hexagonal Te at 375 °C and pure cubic CdTe films at 475 °C with preferred orientation along (111) direction. Under similar conditions, AACVD of [Hg{(TeP₁Pr₂)₂N₂}] resulted in the deposition of hexagonal tellurium, which may be due to reductive elimination of mercury at higher temperatures. Related complexes have also been used to form CuTe, Ag₁Te₁, and AuTe₂ films.

Bis-chelates of cadmium, of the type [Cd₅Pr₂P(X)NC(Y)- NC₄H₄η³-S,O)] (X = S, Y = O; X = O, Y = S), have been used as single-source precursors for the deposition of thin films via AACVD. Preliminary AACVD studies at 400 and 500 °C indicated that metal-enriched CdS formed with a high degree of carbon contamination from the precursor containing a P=O group.

3.2 Groups 13 and 15 (III–V) thin films

The conventional approach to growing III–V thin films is where separate group III and V precursors are combined. The metalorganic precursors traditionally employed are readily available commercially and have convenient vapour pressures. Manasevit first described the use of organometallic compounds to deposit III–V films in 1968, and these original precursors are stillfavoured today. The volatile group III trialkyls, such as trimethylaluminium (AlMe₃), trimethylgallium (GaMe₃), and trimethylindium (InMe₃) in combination
with the group V hydride gases (ammonia, phosphine and arsine) result in III–V thin films that contain low-levels of intrinsic impurities, such as carbon. Hence, the large quantity of ‘active’ atomic hydrogen produced by the pyrolysis of the group V hydride gas results in clean removal of carbon-containing fragments from the growth surface. Later research was aimed at developing safer liquid group V precursors, such as alkyl phosphines and arsines, for use in MOCVD of III–V materials. The most successful replacement for AsH₃ is tertiarybutylarsine (Bu₃AsH₃) as it is a liquid and has a convenient vapour pressure of 81 Torr at 10 °C. Interestingly, a reduction in both oxygen and carbon contamination for GaAs and AlGaAs can be achieved when grown using Bu₃AsH₃ rather than AsH₃.

An alternative approach involved the use of single-source organometallic precursors for III–V semiconducting materials which were mainly studied by Cowley and Jones, Maury and Wells and co-workers. Examples of single-source precursors include [Ga(AsBu₂)₃], [Me₂Ga(µ-AsBu₂)]₂, [H₂GaNH₃]₄, [GaN₅(py)]₃, ([NI₄)(CH₂)₃NMe₂]₂, [BuGaAsEt₄] and [Et₃AlSb(SiMe₃)₂]. The use of single-source precursors to III–V thin films has been reviewed previously and compounds of this type have been typically used to deposit films via MOCVD and low pressure CVD. Solution based routes to III–V thin films are limited although spray pyrolysis to deposit films of GaAs, InP, GaN and AlN have been reported. Thin films of epitaxial gallium nitride on sapphire substrates have also been deposited by chemical solution deposition and via spin coating using liquid precursors such as a gallium dimethylamide-based or carbodiimide-based polymeric precursor. Similarly, cubic AlN and solid-solution Tiₓ-AlₓN films have been deposited using the chemical solution method, polymer-assisted deposition (PAD) where metal–polymer solutions were used as film precursors, where the polymers control the solution viscosity and bind the metal ions to form a homogenous distribution of ions in the solutions. In addition, aerosol-assisted vapour phase processing has been investigated for the synthesis of GaN powders and reduced pressure aerosol deposition using AlN powder produced 10 mm thick AlN films on glass or metal substrates.

We have recently developed AACVD routes to gallium arsenide (GaAs), a semiconductor that is widely used in photovoltaic and optoelectronic devices. Thin film GaAs solar devices have been previously reported with an efficiency of 28.8%, greater than achieved for silicon based devices (amorphous silicon ~ efficiency of 20.1%; crystalline silicon ~ 25.0%). This increased device performance is a result of GaAs having high electron mobility and being more resistant to heat and radiation damage compared to Si due to the higher threshold energy under high energy radiation. In addition, the band gap for GaAs is close to the optimum band gap (1.34 eV) for solar conversion for a single junction solar cell. However, the high cost of fabricating GaAs devices has limited the use of GaAs photovoltaics in niche applications in space and military.

The deposition of high quality polycrystalline GaAs thin films on glass substrates was reported utilizing the single-source precursor, [Me₃GaAs(H)₂Bu₂]. The precursor was synthesised from the reaction of GaMe₃ and Bu₂AsH₂ in a 1 to 1.5 ratio in toluene, as shown in eqn (2). A slight excess of the arsine precursor was necessary to ensure the reaction went to completion. Polycrystalline thin films of GaAs were deposited from [Me₃GaAs(H)₂Bu₂] in toluene via AACVD at 550 °C. Powder XRD indicated that cubic polycrystalline GaAs films had been deposited. The GaAs films were shown by EDAX mapping, X-ray photoelectron spectroscopy (XPS) depth profiling and secondary ion mass spectroscopy (SIMS) to have low incorporation of contaminants, such as carbon due to the facile β-hydride groups present in the precursor. The use of a single-source precursor in the AACVD process allowed for the deposition of films with a Ga to As ratio of 1:1 without the need for a large excess of arsenic source as typically required in dual source deposition techniques currently used for GaAs deposition. These results show the potential of AACVD as a low cost, scalable route to produce high quality thin films of GaAs from single-source precursors at atmospheric pressure.

An alternative arsenic precursor to AsH₃ includes the liquid precursor, tris(dimethylaminoarsine), As(NMe₂)₃ which has been used in MOCVD techniques since the compound is lacking direct As–C bonds, reducing any potential carbon contamination in resulting films and it possesses a low relative decomposition temperature. The main decomposition products of As(NMe₂)₃ have been shown to include dimethylamine, hydrogen and aziridine. The deposition of polycrystalline GaAs thin films on glass substrates from the AACVD of a one-pot solution of the commercially available precursors, As(NMe₂)₃ and GaMe₃, in toluene has been described. The resulting GaAs films were stoichiometric when a 1.5 to 1 ratio of As(NMe₂)₃ and GaMe₃ was used in the AACVD solution. The films were relatively low in carbon and oxygen contaminations as shown by cross sectional EDA X mapping. The films were shown to have a structured morphology due to the high CVD growth rate, as shown by the SEM micrographs in Fig. 5.

3.3 Groups 13 and 16 (III–VI) thin films

Access to unusual or metastable phases using single-source precursors are possible either because of kinetic control of a metastable phase or because of entry into an unusual part of a phase diagram since lower deposition temperatures are often associated with the use of such precursors. Controlling the deposited phase by the molecular design of the precursor has been investigated in the CVD of gallium and indium chalcogenides. The III–VI compounds are semiconductors which find application in photocatalysis, optoelectronic and photovoltaic devices. For example, solar cells based on indium sulfide, β-In₅S₄, have shown a power conversion efficiency of 16.4%, comparable to the more toxic CdS based solar devices. They also have a potential application as passivating layers for III–V devices and are related to ternary phases, such as CuInE₂...
Ga$_2$S$_3$ films were obtained from both compounds with no relatively low temperatures of 275–310°C the elimination of thioacetic anhydride was observed. At the different deposition temperatures, as shown in Fig. 6. As expected, improved crystallinity was observed as the deposition temperature increased. When used in combination with the copper complex, thin films of CuInS$_2$ were deposited by using a 1:1 molar ratio of [In(S$_2$P$_{iBu}$)$_3$] and [Cu(S$_2$P$_{iBu}$)$_3$(PPh$_3$)$_2$]. The deposited In$_2$S$_3$ and CuInS$_2$ thin films showed good coverage over the entire substrate and good crystallinity and hence may be suitable as a photoabsorber in solar devices. Similarly, CuInSe$_2$, CuGaSe$_2$ and CuIn$_{0.7}$Ga$_{0.3}$Se$_2$ thin films have been deposited on glass substrates using the related [M$_2$(Se$_2$P$_{iPr}$)$_2$N]$_2$ precursors (M = Ga, In, Cu) at 300–350°C. AAVCD of the indium precursor [In$_2$(S$_2$P$_{iBu}$)$_3$] at 300–500°C in toluene yielded thin films of indium selenide in the γ-In$_2$Se$_3$ phase. The best films were deposited at 450°C and SEM showed uniform coverage with highly crystalline grains deposited. Different morphologies of the grains were obtained at the different deposition temperatures, as shown in Fig. 7.

The complexes, [Ga(μ-Te)((TeP$_{Pr}$)$_2$N)$_2$]$_2$, and [In(μ-Te)((TeP$_{Pr}$)$_2$N)$_2$]$_2$ were synthesised as shown in Scheme 3 and used as precursors in an AACVD process due to their low volatility. The gallium precursor resulted in the deposition of a mixture of cubic Ga$_2$Te$_3$, monoclinic GaTe and hexagonal Te at 425–475°C. The formation of elemental tellurium is most likely to be due to decomposition of the precursor. Pure cubic In$_5$Te$_3$ films were deposited by AACVD of the indium precursor at 375–475°C. The films were shown to be rough and granular by SEM, which is generally associated with the delivery of precursors as droplets and a homogeneous reaction contribution during the AACVD process.

**Scheme 2** Decomposition of [GaMe(SCOMe)$_2$(dmpy)] and [Ga(SCOMe)$_3$- (dmpy)].

An alternative class of single-source precursors based on the bidentate bis(diisopropylselenophosphoryl)amide ligand, [NH(SeP$_{iPr}$)$_2$] have been used to deposit III–VI materials. The compounds [R$_2$M(SeP$_{Pr}$)$_2$N] (M = Ga, R = Me; M = In, R = Me, Et) were synthesised from the reaction of MR$_3$ with NH(SeP$_{Pr}$)$_2$. Thin films of cubic-Ga$_2$S$_3$ were grown from the gallium precursor in toluene by AACVD at 450 and 475°C. Similarly, thin films of hexagonal γ-In$_2$Se$_3$ were deposited from the methyl indium derivative. The related compound [In(S$_2$P$_{Pr}$)$_2$N$_2$Cl] was shown to deposit polycrystalline tetragonal β-In$_2$S$_3$ films via AACVD.

Thin films of α-Ga$_2$S$_3$ have been deposited by AACVD from [GaMe(SCOMe)$_2$(dmpy)] (dmpy = 3,5-dimethylpyridine). The decomposition of the precursor shows two distinct steps of mass loss. The first step corresponds to the loss of dmpy and thioacetic acid and the second to the loss of acetone, as shown in Scheme 2. On heating the related compound, [Ga(SCOMe)$_3$- (dmpy)], dissociation of the compound in solution. In contrast, the AgAs(NMe$_2$)$_3$ and GaMe$_3$ at (a) 500°C and (b) 550°C. Gallium sulfide (GaS) exists as a hexagonal layered structure. A range of techniques have been used to deposit III–VI thin films including solvothermal, spray ion layer gas reaction, electrostatic spray assisted vapour deposition and low pressure CVD. Examples of precursors to metal chalcogenides have been reviewed.

Mixed alkyl/dithio or diselenocarbamates of gallium and indium can act as precursors to III–VI materials. Compounds of general formula [R$_2$M(S$_2$CNR$_2$)] (M = Ga, R = Et, Me$_2$) have been synthesised and they range from liquids (M = Ga) to low melting solids (M = In). Gallium sulfide (GaS) films have been grown by MOCVD whereas thin films of various phases of In$_5$S$_3$ were grown by low pressure CVD.

Fig. 5 SEM images of crystalline GaAs films grown via AACVD from As(NMe$_2$)$_3$ and GaMe$_3$ at (a) 500°C and (b) 550°C. Reproduced from ref. 63 with permission from The Royal Society of Chemistry.
Dithiocarbamate complexes have also been used as precursors to III–VI thin films in AACVD processes. Indium dithiocarbamates, of the type $[\text{In}(\text{S}_2\text{CNRR}_0)_3/C_1n(py)]$ (where py = pyridine, $R = R_0 = \text{Cy}$, $n = 2$; $R = R_0 = \text{nPr}$, $n = 1.5$; $NRR_0 = \text{Pip}$, $n = 0.5$; $R = \text{Bz}$, $R_0 = \text{Me}$, $n = 0$) were synthesised by the metathetical reaction of sodium dithiocarbamate and indium trichloride in methanol/pyridine solutions, as shown in eqn (3).

Typically addition of a Lewis base yields precursors with enhanced volatility, facile decomposition and sometimes air stability. For these indium complexes, the pyridine did not coordinate to the metal centre but it was present as solvate molecules in the crystal lattices of three of the compounds and the compounds were found to be air and moisture stable. AACVD using the $[\text{In}(\text{S}_2\text{Piv})_3/C_1n(py)]$ precursors in toluene at $300–450 \degree C$ resulted in the deposition of tetragonal $\beta$-$\text{In}_2\text{S}_3$ thin films. The morphology of the resulting films were shown by SEM to vary with rise in substrate temperature, as shown in Fig. 8, with granular crystallites, multi-shaped interconnected crystallites and agglomerates of particles forming. UV-vis measurements of the $\beta$-$\text{In}_2\text{S}_3$ films showed band gap energies of 2.2 eV. Films deposited from $[\text{In}(\text{S}_2\text{PCy})_3/C_2\text{py}]$ were shown to be promising for application in solar cells (vide infra). Thin films of CuSnS$_2$, CuInS$_2$, CuInSe$_2$ and CuGaSe$_2$ have also been grown via AACVD using the precursors $[\text{M}($E$_2\text{CNMe}_n\text{Hex})_3]$ ($E = \text{S, Se}; M = \text{Ga, In}$) and $[\text{Cu}($E$_2\text{CNMe}_n$Hex)$_3]$.

\[\text{InCl}_3 + 3\text{Na}(\text{SCNRR}_0')\text{Pyridine} \rightarrow [\text{In}(\text{S}_2\text{CNRR}_0')]_3\text{n(py)} + 3\text{NaCl}\] (3)

3.4 Groups 14 and 16 (IV–VI) thin films

Tin sulfide is a IV–VI semiconductor which has three main phases: (i) SnS$_2$, (ii) SnS and (iii) Sn$_2$S$_3$ which is a mixed Sn(II)/Sn(IV) compound. The band gaps of SnS, SnS$_2$ and Sn$_2$S$_3$ are 1.3 eV, 2.18 eV and 0.95 eV respectively, and all three forms exhibit semiconducting properties. SnS has attracted a lot of attention due to its band gap, which lies between that of GaAs and silicon and depending on the tin content, SnS can be a p-type or n-type conductor. Thin films of tin(II) and tin(IV) sulfides have been investigated as semiconductors, solar collectors and photovoltaic materials. A range of methods have been used to deposit thin films of tin sulfide including spray deposition, chemical bath deposition, atomic layer deposition and dip deposition. A recent review by Lewis et al. outlines a range of methods for the deposition of thin films of binary tin chalcogenides, tin sulfide (SnS), selenide (SnSe) and telluride (SnTe), as well as describing methods to make their nanocrystalline analogues.

Tin sulfide films have been grown from single-source thiolate precursors by AACVD. The precursor, $[\text{Sn}($SCH$_2\text{CH}_2\text{S})_2]$ was prepared from the reaction of ethane-1,2-dithiol, 2 equiv. of $^9\text{BuLi}$ and SnCl$_4$. AACVD of $[\text{Sn}($SCH$_2\text{CH}_2\text{S})_2]$ in acetone in the presence of $\text{H}_2\text{S}$ at $350–550 \degree C$ resulted in the deposition thin films of tin sulfides. The deposition temperature dictated...
which phase of tin sulfide was deposited; SnS$_2$ at 350 °C, SnS$_3$ at 400 °C and SnS at 500 °C and above. The use of AACVD as the deposition technique was necessary as the precursor was involatile and had poor carry over under atmospheric pressure CVD conditions. AACVD of [Sn(SCH$_2$CH$_2$S)$_2$]$_2$py without the use of H$_2$S also resulted in the formation of tin sulfide films with SnS and a trace of Sn$_2$S$_3$ formed at 400 °C and at 500 °C and above single phase SnS. No films were deposited at 350 °C or below. AACVD of the tin monothiolate compound, [Sn(SPH)$_3$]$_2$ was shown to decompose by disulfide (RS-SR) elimination to leave reactive tin metal, which was readily oxidized to SnO$_2$ in the absence of added H$_2$S. In general, [M(SR)$_4$] molecules have significant distortion from tetrahedral geometry due to non-covalently bonded S···S interactions which promotes the disulfide elimination pathway. The use of a chelating bis-thiolate in [Sn(SCH$_2$CH$_2$S)$_2$]$_2$py eliminates the possibility of this occurring, hence it can successfully act as a single-source precursor for tin sulfide films. AACVD of [Sn(SPH)$_3$]$_2$ with H$_2$S added as a co-reactant did yield tin sulfide films with the film deposited at 450 °C consisting of mainly SnS$_2$ while at 500 °C SnS was the dominant component.

Other single-source precursors that have been used in AACVD of tin sulfides include [B$_2$Z$_2$SnCl(L)] (L = thiosemicarbazones of 4-chlorobenzaldehyde and salicylaldehyde, Bz = benzyl) in toluene at 270–370 °C to deposit SnS$_2$ at 350 °C and a range of dithiocarbamate complexes have also been investigated. Unsymmetrical tin(n) dithiocarbamates, of the type [Sn(S$_2$CNRR')$_2$]$_2$ (R = Et, R' = Et; R = Me, R' = Bu) were synthesised either by direct reaction of the sodium salt of the dithiocarbamate with SnCl$_4$ or via reaction of CS$_2$ with a secondary amine in the presence of a base followed by metallathesis of SnCl$_4$. AACVD of [Sn(S$_2$CNRR')$_2$]$_2$ was carried out in THF at 450 and 500 °C. SnS was deposited with some contamination from SnO$_2$ and the effect of concentration of the precursor solution was studied. The use of higher concentrations of precursors was found to be key for the formation of stoichiometric or near-to-stoichiometric films of SnS for all precursors studied, as shown in Fig. 9. A direct band gap of 1.2 eV was estimated for the films and the morphology was shown by SEM to consist of bundles of sheets comprised of small crystallites.

A series of related organotin dithiocarbamates, [Sn(C$_4$H$_9$)$_2$-(S$_2$CNRR')$_2$] (R = Et, R' = Et, Me, Bu; R = Me, R' = hexyl) were synthesised via the reaction of BuSnCl$_4$ with the sodium salt of the dithiocarbamate. The compounds, [Sn(C$_4$H$_9$)$_2$(S$_2$CNMe$_2$Bu)$_2$]$_2$ and [Sn(C$_4$H$_9$)$_2$(S$_2$CNBu$_2$)$_2$]$_2$ were characterised by single crystal X-ray diffraction which showed that the tin has four covalent bonds (2C and 2S) in a distorted tetrahedral geometry. A weaker bonding interaction with tin along the tetrahedral face occurs from the other S atom on each dithiocarbamate ligand, as shown in Fig. 10. Therefore there are two types of Sn–S bonds, one shorter covalent Sn–S bond (~2.526 Å) and a longer weaker Sn–S bond (~2.940 Å). AACVD of [Sn(C$_4$H$_9$)$_2$-(S$_2$CNRR')$_2$]$_2$ (R = Et, R' = Et, Me, Bu; R = Me, R' = hexyl) in toluene at 400–530 °C resulted in the deposition of tin sulfide thin films. No deposition occurred at substrate temperatures below 400 °C. All the compounds primarily deposited SnS, however the presence of some SnO$_2$ was detected by powder XRD. Hall effect measurements indicated that all the films were p-type semiconductors, which is believed to originate from high concentration of Sn vacancy sites. Band gaps varied from 1.2 to 1.7 eV for the films and the highest photosensitivity (2.1%) was obtained from deposition carried out at 500 °C using [Sn(C$_4$H$_9$)$_2$(S$_2$CNMe$_2$Bu)$_2$]. Compounds of this type have also been used to deposit thin films of Cu$_2$(Zn$_{1-y}$Fe$_y$)$_4$SnS$_4$ (CZFTS) via AACVD in combination with Cu, Fe and Zn dithiocarbamate complexes.

Thin films of SnSe have been deposited by AACVD using either [Sn(Se$_2$PPh$_3$)$_2$]$^{100}$ or [Bu$_2$Sn(2-SeC$_5$H$_4$N)$_2$] in THF and from SnO$_2$ and the effect of concentration of the precursor solution was studied. The use of higher concentrations of precursors was found to be key for the formation of stoichiometric or near-to-stoichiometric films of SnS for all precursors studied, as shown in Fig. 9. A direct band gap of 1.2 eV was estimated for the films and the morphology was shown by SEM to consist of bundles of sheets comprised of small crystallites.
Dithiocarbamates have also been used to deposit thin films of PbS. Lead chalcogenides are narrow band gap semiconductors with band gaps of 0.41 and 0.27 eV for PbS and PbSe, respectively and find application in high performance photoconductive infrared detectors. AACVD of the precursors [Pb(S_{2}CNMe_{2}Bu)_{2}] (R = Me, R' = benzyl, heptyl, octadecyl; R = R' = diocetyl or Et) in toluene at 350–525 °C on glass substrates resulted in featureless, highly reflective and pinhole-free cubic PbS thin films with good surface coverage. The morphology changed from globular crystallites to a disordered network of wires from low to high temperature. AACVD of [Pb{(TeP_{iPr_{2}})_{2}N}]_{2} below 475 °C resulted in films composed of PbTe and Te, but at 475 °C phase-pure cubic PbTe films were deposited. The surface coverage was poor and significant amounts of precursor remained in the precursor solution flask at the end of the AACVD depositions due to the poor solubility of the precursor. Films of PbTe with improved phase purity were obtained by using a hot-injection process.

3.5 Groups 15 and 16 (V–VI) thin films

Binary metal chalcogenides incorporating group 15 and 16 elements, of the type M_{2}E_{3} VI (M = As, Sb, Bi; E = S, Se, Te)
are an important class of semiconductors that are already used in a range of technological applications, including electronic and optoelectronic devices, thermoelectric devices and photoconducting targets. Thin films of these materials have been deposited using the solution-based techniques of spray deposition, spin coating, chemical bath deposition and solvothermal, as well as via low pressure MOCVD. However, many of these methods require complicated manipulations and equipment or have high production costs and more facile routes to fabricate V–VI thin films at low cost and in scalable ways are being investigated and a number of deposits using AACVD have been described.

AACVD of the bismuth dithiocarbamate, \([\text{Bi(S}_2\text{CNEt}_2)_3]\), using a range of solvents – chloroform, dichloromethane or a 1:1 mixture of chloroform and toluene at 350–450 °C has been reported. The precursor was prepared from the reaction of potassium dithiocarbamate with \([\text{Bi(NO}_3)_3\cdot 5\text{H}_2\text{O}\) in acetone. As described above, the solvent plays a significant role in determining the morphology and texture of the resulting film. In this study both polar and non-polar solvents were investigated since the polarity and specific heat capacity of the solvent are important during the decomposition process and the droplet size of the aerosol as well as the viscosity of the deposition solution can all be effected. Thin films of Bi$_2$S$_3$ in its orthorhombic stibnite type modification were deposited on FTO coated glass. Films deposited using dichloromethane as the solvent were found to have similar morphology to films deposited from chloroform. SEM images of films deposited from chloroform are shown in Fig. 13, which revealed that the films had complex nanostructures composed of nanotubes grown vertically on the substrate. Films grown from a mixture of chloroform and toluene (1:1) had a compact nanostructure morphology at 400 °C and a more porous structure at 450 °C, as depicted in Fig. 14. The different morphologies observed was explained by the different solvents leading to homogeneous or heterogeneous deposition reactions. During CVD decomposition of the precursor in the gas phase is termed ‘homogeneous’ whilst decomposition on the heated substrate is ‘heterogeneous’, the ratio between these two processes are directly responsible for a number of characteristics. Chloroform facilitates homogeneous reaction during deposition by evaporating and leaving the precursor molecule to vapourise in the heated zone as it is a low specific heat capacity solvent. The homogeneous reaction results in decomposition of the precursor starting in the gaseous phase, after vapourisation, which is followed by nucleation to form Bi$_2$S$_3$ particles. These particles can then be adsorbed onto the substrate surface and a ripening/growing process results in the formation of the nanotubes. However, with addition of toluene, a high specific heat capacity solvent, the vapourisation temperature of the aerosol droplets is increased and heterogeneous reaction is promoted. This means that the vapourised precursor and its gaseous intermediate species are adsorbed onto the surface of the heated substrate where they undergo decomposition and chemical reactions to produce the Bi$_2$S$_3$ thin film. The formation of porous Bi$_2$S$_3$ thin films at 450 °C from toluene/chloroform mixtures is due to a combination of homogeneous nucleation in the gas phase and heterogeneous growth on the substrates.

The related diselenocarbamates, \([\text{Bi(Se}_2\text{CNRR'})_3]\) \((\text{R} = \text{R'} = \text{Et, } \text{Bu, R} = \text{Me, } \text{R'} = \text{Hexyl})\) have been synthesised and used as precursors for the deposition of Bi$_2$Se$_3$ thin films. AACVD of \([\text{Bi(Se}_2\text{CNRR'})_3]\) in THF at 475 °C resulted in the deposition of rhombohedral Bi$_2$Se$_3$ films which were comprised of thin flake-like particles evenly dispersed on the glass substrates. The growth temperature was shown to affect the morphological characteristics of the film when \([\text{Bi(Se}_2\text{CNMe}^5\text{Bu})_3]\) was used as the precursor and deposition temperatures of 450, 475 and 500 °C were investigated. The flake-like deposited particles become predominant as the growth temperature increased and SEM showed that the films were formed by an under layer of nanosized Bi$_2$Se$_3$ particles from which the bigger flake-like particle protrude.

Thin films of rhombohedral Bi$_2$Se$_3$ and orthorhombic Bi$_2$S$_3$ have been deposited on glass substrates from the precursors \([\text{Bi([Se}_2\text{PPr}_2)_3\text{N}_3]}\) and \([\text{Bi([SPR}_2)_3\text{N}_3]}\) \((\text{R} = \text{Pr, Ph})\), respectively, via AACVD. The films were deposited at 400–475 °C using

**Fig. 13** SEM of Bi$_2$S$_3$ deposited via AACVD from \([\text{Bi(S}_2\text{CNEt}_2)_3]\) in chloroform at (a) 350 °C, (b) 400 °C, (c) 450 °C and (d) cross-section of film deposited at 400 °C. The inset of (b) shows a high resolution image of a nanotube. Reproduced with permission from ref. 114. Copyright 2014 American Chemical Society.

**Fig. 14** SEM of Bi$_2$S$_3$ thin films deposited via AACVD from \([\text{Bi(S}_2\text{CNEt}_2)_3]\) in chloroform/toluene at (a) 400 °C, (b) 450 °C, (c) and (d) show cross-section of films deposited at 400 and 450 °C, respectively. Reproduced with permission from ref. 114. Copyright 2014 American Chemical Society.
THF as the solvent. Films were also deposited using these precursors in a low pressure MOCVD process which was found to yield higher quality films than those deposited by AACVD since no detectable phosphorus contamination was observed and the elemental composition were in better agreement with the stoichiometry expected, in contrast to AACVD films which showed some phosphorus contamination and the formation of bismuth rich films. However, a range of different morphologies were obtained using AACVD.

The related antimony telluride precursor, $[\text{Sb}([\text{TeP}i\text{Pr}_2]_2\text{N})]$, dissolved in toluene, was used to deposit pure Sb$_2$Te$_3$ films using the AACVD process at 375–475 °C.$^{117}$ TGA indicated that the precursor decomposed by two decomposition steps. The first weight-loss corresponded to the loss of one ligand moiety, $[\text{TeP}i\text{Pr}_2]_2\text{N}$, at 280 °C and the second step occurred at 325 °C resulting in weight loss suggesting formation of Sb$_2$Te$_3$ by further fragmentation. Therefore, the deposition studies were carried out at 325–475 °C which showed that 325 °C was too low to initiate deposition. Between 375 and 475 °C black reflective films of rhombohedral Sb$_2$Te$_3$ were deposited and SEM showed the formation of randomly orientated plates. Four point probe measurements of the films grown at 475 °C indicated conductivity values between 159 and 180 $\Omega^{-1}$ cm$^{-1}$.

A number of precursors have also been used to deposit thin films of antimony sulfide in AACVD processes. Thin films of Sb$_2$S$_3$ have been deposited from $[\text{Sb(S}_2\text{COR})_3]$ (R = Me, Et, iPr)$^{118}$ which were shown to be superior precursors compared to the related antimony dithiocarbamates, $[\text{Sb(S}_2\text{CNRR}^2)_3]$,$^{119}$ which produced Sb$_2$S$_3$ films prone to oxidation. The antimony xanthate are less thermally robust than the dithiocarbamates and decomposition of $[\text{Sb(S}_2\text{COR})_3]$ was suggested to follow a metal-based-variation on the Chugaev elimination, as shown in Scheme 4, where xanthates (MS$_2$COR) are converted to alkene (RH), OCS and MSH. Powder XRD of the resulting films showed the formation of orthorhombic stibnite Sb$_2$S$_3$ with a minor component of Sb$_{10}$S$_{15}$, a monoclinic variant of Sb$_2$S$_3$. The morphology of the resulting films was shown to change depending on the precursor used.

Antimony thiosemicarbazones, of the type $[\text{SbCl}_3(L)]$ (L = thiosemicarbazones of thiopene-2-carboxaldehyde and cinnamaldehyde), as shown below in Fig. 15 have been used to deposit polycrystalline thin films of Sb$_2$S$_3$ at 320 °C in acetone.$^{120}$ A rod-shaped morphology was obtained where rods of different dimensions had grown in various directions. The optical band gap for the films was found to be 3.48 eV. Thin films of antimony selenide and bismuth selenide have been grown using 2-pyridyl selenolates, of the type $[\text{M(Se-C}_5\text{H}_3(\text{Me-3})\text{N})_3]$ (M = Sb, Bi), in an AACVD process.$^{121}$ The structure of the bismuth precursor is shown in Fig. 16. Bismuth selenide films, corresponding to rhombohedral Bi$_3$Se$_4$, hexagonal Bi$_3$Se$_3$, hexagonal BiSe were obtained from the bismuth compound depending on the duration and temperature of the depositions whereas Sb$_2$Se$_3$ was deposited using the antimony precursor.

### 4 Main group TCOs

Section 3 described the AACVD of main group semiconductors whereas this section focuses on a particular type of semiconductor, the transparent conducting oxides (TCOs). For semiconductors to be transparent they have to absorb light at energies higher than the highest energy of visible light, which correlates to ~3.0 eV. TCO materials must display high transparency (>80% transmittance in the visible) and high electrical conductivity. Thin film TCOs play a major role in the fabrication of a range of devices including in solar cells, optical sensors, flat panel displays and architectural glass applications and they have been used in thin film transistor (TFT) applications. The conductivity of a semiconductor is at least an order of magnitude lower than that of a metal,$^{122}$ however doping is a
common method to increase conductivity whilst remaining optically transparent. Better drive capacities and electrical stability are key to the improvement of TFT technologies.123,124

The vast majority of TCOs are based on In$_2$O$_3$, SnO$_2$, ZnO and their ternary metal oxides. These oxides exhibit n-type characteristics with electron mobility as high as 90 cm$^2$ V$^{-1}$ s$^{-1}$.125 The development of p-type materials (hole transporting as opposed to the electron transporting, n-type) has been considerably slower. There have been many challenges faced in the development of materials exhibiting p-type characteristics126,127 and they are limited to materials, such as Cu$_2$O and SnO.128

Recent research into the conductivity of n-type metal oxides has shown improvement in oxygen deficient films, leading to the belief that oxygen vacancies and metal interstitials act as electron donors.129 Theoretical and experimental work has also shown that hydrogen could play a part in n-type conductivity.130,131 However, the more traditional route of introducing impurities, or doping, is still the favoured, more controlled method to enhancing the conducting properties of the material and recent developments in the AACVD of TCOs will be described (vide infra). As devices approach their top performance, cheaper alternatives are desired, driving forward the market of inexpensive disposable electronics. Solution deposition of semiconducting main group oxides has seen much growth in the last decade from both academic and industrial research labs.129 Solution based techniques would simplify multi-step synthetic procedures and lower the cost whilst still delivering a high performance. Currently there are a number of solution based techniques all with their advantages and drawbacks, including sol–gel, spray pyrolysis and dip coating.132–134 A recent review describes the AACVD of organic–inorganic nanocomposite coatings using cold plasma135 and ZnO materials and devices have also been reviewed.136

Single-source or molecular precursors can be used for the formation of thin film metal oxide materials without an additional oxygen input.137 These precursors can provide a clean and facile decomposition route that can often be more environmentally friendly, less toxic/expensive whilst at the same time eliminating the need for a mixture of precursors. Gallium oxide, indium oxide and tin oxide and their ternary oxides show excellent electrical conductivity and find application in the field of gas sensing (Section 6) and TCOs.138

4.1 Gallium and indium oxides

The β-form or monoclinic phase of gallium oxide is the most common observed, which is not usually crystalline until 900 °C, although there are reports of crystalline films grown at 600 °C,139,140 although this seems to be unusual with typical conversion occurring ~700 °C.141 Whilst gallium oxide is amorphous at lower temperatures it shows semiconducting behaviour above 450 °C and changes in resistivity depending on the concentration of various reducing gases. Precursors to gallium oxide have received much interest and have been described in some reviews.137,142–144 Recent developments on the AACVD of gallium oxide are described below.

Single-source precursors of gallium oxide can be grouped into three major classes: alkoxydes, β-diketones and β-ketoiminates (Fig. 17). Gallium alkoxyde precursors that yield thin films of Ga$_2$O$_3$ are well reported142,145 with synthetic routes including reaction of trialkyl gallium with alcohols,139,146 reaction of GaCl$_3$ with the salt of an alcohol147 and reaction of gallium amides with alcohols.148,149 Within the remit of ‘alkoxide’ are a number of subdivisions, including the simpler monodentate alkoxydes (e.g. methoxide, ethoxide) and also donor-functionalised alkoxydes which are more commonly seen as precursors in AACVD because of their ability to split oligomers into monomers via the coordination of a Lewis base.145 Whilst there are a number of variants to these donor-functionalised ligands, which improve solubility for use in AACVD and volatility for use in other types of CVD, carbon contamination is kept to a minimum with the use of shorter chains. As such it is more commonly seen that alcohols, of the type HOCH$_2$CH$_2$YR$_x$ (Y = O, R = Me, x = 1; Y = N, R = Me, Et, x = 2) are used in the vast majority of reported cases, with the YR$_x$ moiety acting as the Lewis base.130 The precursors were synthesised via a 1 : 1 reaction of GaMe$_3$ with a donor-functionalised alcohol to yield the gallium mono-alkoxides, [Me$_x$Ga(OCH$_2$($CH_2$YR$_x$)$_{2-x}$)].151 However, higher ratios of alcohol to trialkyl gallium resulted in the formation of mixtures of the gallium mono- and bis-alkoxides [Me$_{1-n}$Ga(OCH$_2$($CH_2$YR$_x$)$_n$)]$_2$.152 Monomeric gallium bis-alkoxides, of the type [Cl$_x$Ga(OCH$_2$($CH_2$YR$_x$)$_2$)] could be isolated from the reaction of GaCl$_3$. In contrast, the addition of one equivalent of a donor-functionalised alcohol yields the dimeric gallium monoalkoxides, [Cl$_x$Ga(OCH$_2$($CH_2$YR$_x$)]. A solution to this was the use of an amine elimination route, which enabled the isolation of mono-, bis- and tris-alkoxides, which have all been used to produce films of Ga$_2$O$_3$ via AACVD.153,154

The alkylgallium mono-alkoxides were initially used in low pressure CVD, however oxygen deficient thin films of gallium oxide were deposited. AACVD was then investigated due to the high solubility of the precursors in a range of solvents and in order to deposit higher purity gallium oxide.139,140 Rather than isolate and purify the dialkyl/gallium monoalkoxide it was generated in situ. This resulted in the AACVD reaction of GaR$_3$ (R = Me, Et) and excess R’OH (R’ = C(CH$_3$)$_3$CH$_2$OMe, CH$_2$CHO Me, CH$_2$CH$_2$NMe$_2$, CH(CH$_3$)CH$_2$NMe$_2$, CH(CH$_2$NMe$_2$)$_2$) in toluene at 450 °C yielding stoichiometric Ga$_2$O$_3$ thin films with minimal carbon contamination. The gallium oxide films showed minimal reflectivity (5–10%) and high transmission (80–90%) with

![Fig. 17 Single-source precursors for gallium and indium oxide (M = Ga, In).](image-url)
a band gap of 4.5 to 4.7 eV. Excess alcohol was used to reduce the oxygen deficiency of the films. The films deposited using GaEt₃ were transparent, whereas those from GaMe₃ were brown, which suggests a higher incorporation of carbon in the latter. The lower carbon observed when using the ethyl-derivative is most likely due to a facile β-hydride elimination being available for this ligand (but not the methyl).

Thin films of Ga₂O₃ have also been deposited by AACVD from the reaction of [Ga(NMe₂)₃] with a range of donor-functionalised alcohols, ROH (R = CH₂CH₂NMe₂, CH(CH₂NMe₂)₂, CH(CH₃)-CH₂NMe₂, CH₂CH₂OMe and C(CH₃)₂CH₂OMe).¹⁴⁵ The films were deposited at 550 °C from toluene solutions and simply changing the donor-functionalised alcohol yielded differing morphologies. As shown in Fig. 19, a spherical morphology resulted from the use of HOCH(CH₂NMe₂)₂ with [Ga(NMe₂)₃]₂, whereas fractals resulted from HOCH(CH₃)CH₂NMe₂.

We have also used donor-functionalised groups to stabilize gallium hydride species, of the type [(GaH₂(L₃))₂] and [(GaH(L₃))]²⁻ (where Lₙ = {Me₃-N(CH₂CH₂O)ₓ} and x = 1, 2) that are stable and isolable at room temperature, as shown in Fig. 20.¹⁵⁵ The gallium tris(alkoxide)complex [Ga(L₃)]³⁻ and the related dimeric complex [(GaMe(L₃))]₂, have also been used as single-source precursors for the deposition of Ga₂O₃ via AACVD with toluene as solvent. The resulting films were mostly transparent, indicating low levels of carbon contamination, and they were also mainly amorphous. The hydride compounds, [(GaH₂(L₃))]²⁻ and [(GaH(L₃))]²⁻ both afforded gallium-containing films, but the best film was deposited using homoleptic [Ga(L₃)]³⁻, which formed crystalline material, underneath microscale wires, at a substrate temperature of 450 °C.

As far back as 20 years ago commercially available ‘simple’ β-diketonates, such as [Ga(acac)₃], have been used to grow films of Ga₂O₃ with limited success and high carbon contamination was observed in the resulting films.¹⁵⁶–¹⁵⁸ Accessible through facile synthetic routes,¹⁵⁹–¹⁶¹ gallium tris(β-diketonate) form air stable six coordinate octahedral species, of the type [Ga(O₂{R})₃]⁺ (O₂{R} = β-diketonate ligand). Recently, the use of these precursors for the deposition of spinel materials via AACVD has been reported.¹⁶²,¹⁶³ However, attempts to synthesise compounds of the type [GaX(O₂{R})₂] (X = Cl, Me, H) for use in CVD failed and this further evidenced the thermo-dynamic stability of the homoleptic tris(β-diketonates) which formed instead.¹⁶⁴ Despite excellent solubility, the stability of gallium β-diketonates has meant that they are not ideal precursors for use in AACVD.

Gallium β-ketoiminate compounds are a more recent addition to the library of gallium precursors that currently exist. β-Ketoiminate ligands, when compared to bidentate ligands such as donor functionalised alcohols, have the advantage in that they can be easily tailored to be bi- or tetra dentate. The added functionality of groups attached to the nitrogen moiety in β-ketoimine ligands enables fine tuning of the precursor, in comparison to alkoxides and β-diketonates. The β-ketoiminate compounds contain a direct M–O bond within a de-localised ring containing O and N donor atoms (Fig. 17), allowing more steric bulk to be brought into the coordination sphere of the metal centre, which can prevent oligomerisation improving precursor volatility and solubility. Furthermore, varying the R group on the N donor atom can not only increase the steric demand of the ligand, but also, with use of a polyether for example, yield multidentate ligands.¹⁴² AACVD of the β-ketoiminate gallium hydride compounds,
been reported and their thermal degradation to Ga$_2$O$_3$ (80–90% in the visible) and low carbon contamination. Pounds of this type could produce films with high transparency. This work was particularly significant because it showed that compounds of this type could produce films with high transparency (80–90% in the visible) and low carbon contamination (<5%), significantly less than the brown films typically deposited via dialkylalkoxogallanes.

More recently, the effect of changing the $\beta$-ketiminato ligand on the geometry and stability of gallium and aluminium precursors was studied. The synthesis and crystal structures of [Ga(MeCN)(iPr–CHC(Me)=O)$_2$] and [Ga(MeCN)(iPr–CHC(Me)=O)Cl] in a trigonal bipyramidal geometry and [Ga((CH$_2$)$_2${NC(Me)–CHC(C$_6$H$_5$)=O})$_2$]Me in a square based pyramid were reported and their AACVD described (Fig. 21). Both compounds produced thin films of Ga$_2$O$_3$ on glass at 450 °C with toluene as the solvent. In addition to gallium alkoxides and $\beta$-ketiminate, gallium siloxide compounds, of the type [Me$_2$Ga(OR)$_2$] (SiEt$_3$, Si(OBu)$_3$) have been reported and their thermal degradation to Ga$_2$O$_3$ was proven via TGA.

Unlike the lighter members of group 13 the oxide of indium is cubic and crystalline at 300 °C, and no phase change is observed even under AACVD conditions of 600 °C. As a material, the oxide is used in a range of devices from solar cells to gas sensors, however routes to thin film deposition has posed a problem, largely due to the lack of suitable precursors. With a view to this there has been much work in the last decade on the synthesis of indium precursors that are soluble so that they can be used in the AACVD of In$_2$O$_3$ and a comprehensive review of indium precursors has been published.

In a similar manner to the gallium oxide precursors, indium oxide precursors can be grouped into two categories, namely alkoxides (Fig. 22) and $\beta$-diketonates until recently, however a range of $\beta$-ketiminate precursors have now been reported.

\[
[\text{GaMe}_2(L_3)] \quad \text{and} \quad [\text{GaH}_2(L_4)] \quad (L_3 = (\text{CH}_2)_2\{\text{NC}([\text{Me}]\text{CHC}([\text{Me}]=O)\}_{2}; \\
L_4 = \text{Me}_2\text{N}((\text{CH}_2)_2\{\text{NC}([\text{Me}]\text{CHC}([\text{Me}]=O)\} \text{in toluene at 450 °C deposited thin films of Ga}_2\text{O}_3.\text{ Superior films were deposited using } [\text{GaH}(L_3)] \text{ (Fig. 17c and d, } X = \text{H}) \text{ in comparison to } [\text{GaH}_2(L_4)] \text{ resulting in transparent adherent films. These precursors also highlighted the advantages of AACVD as low pressure CVD was unsuccessful owing to the rapid decomposition of the precursors. However, solutions of the precursors were easily transported in an aerosol mist and deposited onto quartz substrates. Annealing the films at 1000 °C afforded crystalline films of Ga$_2$O$_3$. This work was particularly significant because it showed that compounds of this type could produce films with high transparency (80–90% in the visible) and low carbon contamination (<5%), significantly less than the brown films typically deposited via dialkylalkoxogallanes.}

More recently, the effect of changing the $\beta$-ketiminato ligand on the geometry and stability of gallium and aluminium precursors was studied. The synthesis and crystal structures of [Ga(PhCN)(Me–CHC(Me)=O)$_2$Cl] in a trigonal bipyramidal geometry and [Ga((CH$_2$)$_2${NC([Me]CHC([Me)]=O})$_2$]Me in a square based pyramid were reported and their AACVD described (Fig. 21). Both compounds produced thin films of Ga$_2$O$_3$ on glass at 450 °C with toluene as the solvent. In addition to gallium alkoxides and $\beta$-ketiminate, gallium siloxide compounds, of the type [Me$_2$Ga(OR)$_2$] (SiEt$_3$, Si(OBu)$_3$) have been reported and their thermal degradation to Ga$_2$O$_3$ was proven via TGA.

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In a similar manner to the gallium oxide precursors, indium oxide precursors can be grouped into two categories, namely alkoxides (Fig. 22) and $\beta$-diketonates until recently, however a range of $\beta$-ketiminate precursors have now been reported.

Fig. 21 ORTEP diagrams showing [Ga(PhCN)(H)(Ph–CHC(Ph)=O)Cl], left and [Ga((CH)$_2$)$_2$[Ni(Ph)Me–CHC(Ph)$_2$–O)$_2$]Me], right. Thermal ellipsoids are drawn at 50% probability. Reproduced from ref. 168 with permission from the Centre National de la Recherche Scientifique (CNRS) and the Royal Society of Chemistry.

Literature routes to alkoxide compounds of indium often result in the formation of indium oxo alkoxo-clusters rather than isolated homoleptic alkoxides. This may go some way towards explaining why the availability of volatile indium alkoxide precursors is limited. Bis- or tris-alkoxides of indium cannot be synthesised from reaction of In$_2$O$_3$ and alcohols (mono- or donor-functionalised) and so amine elimination routes must be used, with [In(N(SiMe)$_3$)$_3$] being a typical starting material. Whilst this can yield homoleptic complexes, attempts to synthesise heteroleptic indium alkoxides were unsuccessful and instead the silylamide group of the ligand was observed to migrate, resulting in the formation of dimeric species.

Solution based studies have shown that the reaction of In$_2$O$_3$ and donor-functionalised alcohols form in situ compounds of the type [Me$_2$In(OR)]$_2$ (R = donor-functionalised ligand). As with gallium, this reaction of an alkyl indium species with a donor-functionalised alcohol (ROH, e.g. R = CH$_2$CH$_2$NMe$_2$, CH$_2$CH$_2$OMe) can be carried out in situ in the AACVD process, which removes the additional isolation step required in many techniques. These reactions in toluene solution can be made into an aerosol using an ultrasonic humidifier and used in AACVD to deposit thin films of In$_2$O$_3$ (Fig. 23). The films were deposited at 550 °C, of varying thickness indicated by the clearly visible interference fringes shown on the glass. The films were characterised fully and shown to displayed minimal reflectivity (5–10%) and high transmission (80–90%). Owing to the porosity of the films they were shown to be hydrophilic, with water contact angles of 28°. The success of this work highlighted not just the energy cost but also the time efficiency of in situ AACVD, and the methodology has since been applied to a number of systems. SEM of the films showed that a change in morphology was observed as the donor-functionalised alcohol was altered (Fig. 23).

Indium $\beta$-diketonate precursors, much like their gallium analogues are thermodynamically stable and sublimation of [In(acac)$_3$] is not observed until almost 200 °C. As with the equivalent synthetic routes employed with gallium, attempts to isolate heteroleptic indium $\beta$-diketonates failed, with only the tris($\beta$-diketonate) isolated.

It has been recently reported that the morphology of a film can be significantly altered by changing the solvent and/or temperature used in the AACVD process. Thin films of In$_2$O$_3$ were deposited at 350–500 °C on glass from In$_3$N$_3$ in methanol resulting in n-type conductivity with a resistivity of 8.60 × 10$^{-5}$ Ω cm and a charge carrier concentration of 9.30 × 10$^{19}$ cm$^{-3}$ with mobility of the charge carriers reported to be...
77.0 cm² V⁻¹ s⁻¹. For comparison, films of In₂O₃ were also deposited via AACVD from mixtures of InMe₃ and the donor functionalised alcohol, HOCH₂CH₂NMe₂ in methanol, which resulted in resistivity of 3.66 × 10⁻³ Ω cm and a charge carrier concentration of 2.12 × 10²⁰ cm⁻³ with mobility of the charge carriers reported to be 79.9 cm² V⁻¹ s⁻¹. Overall the presence of the donor-functionalised alcohol did improve the coverage and conductivity with the sheet resistance reported to be 4.88 Ω sq⁻¹ compared with 3.44 Ω sq⁻¹ for the InMe₃/methanol system. SEM was used to compare the resultant morphologies of the films deposited. In₂O₃ deposited below 400 °C from InMe₃ and methanol were flat and featureless, however increasing the deposition temperature to 450 °C, resulted in the formation of agglomerated clusters, as shown in Fig. 24. The addition of the donor-functionalised alcohol gives a completely different morphology and the variation in film morphology was shown to be the result of changes in both temperature and the use of methanol.

Indium siloxide precursors of the type [Me₂In(OR)] (R = SiEt₃, OSi(O’Bu)₂),¹⁶⁹ have been synthesised and TGA analysis showed the former to thermally degrade to In₂O₃, whilst the latter formed the silicate. More recent work from the same group has reported the synthesis of novel indium(III)-tin(II) alkoxides, which under thermal treatment yielded amorphous tin-rich ITO and crystalline ITO with traces of SnO₂.¹⁷⁷

4.2 Ternary main group TCOs

Currently indium tin oxide (ITO) is the industrial standard and is used in most TCO materials. The availability of indium and therefore price still remains a concern and alternatives are actively being investigated. Gallium doped indium oxide, In₂O₃:Ga and fluorine doped tin oxide, SnO₂:F are two viable options and whilst these materials have been deposited by a range of techniques,¹⁷⁸–¹⁸⁰ APCVD for the synthesis of titanium oxide,¹⁶⁷ were transparent and XRD confirmed a homogenously Ga substituted cubic In₂O₃ structure. There has been much interest in the synthesis of the best performing gallium doped indium oxide, not least for its improved transmission in the blue green.¹⁶⁶,¹⁸¹ The material has been studied using a novel combinatorial AACVD (cAACVD) methodology (Fig. 25). The set up for cAACVD has two separate inlets, which when one is loaded with dopant and the other the main precursor gives rise to the production of films with a compositional gradient. A grid system is then used to analyse the films, such that conductivity, transmission, thickness, dopant% and film morphology, can all be mapped against each other. This method, despite requiring large amounts of analysis does provide a single deposition route to the optimisation of functional materials. This technique has been applied to LPCVD in the investigation of multi metallic oxide materials,¹⁸²–¹⁸⁴ and varying niobium doping in anatase.¹⁹⁰

Combinatorial AACVD was used for the first time to produce films of gallium-indium-oxide which showed compositional gradient across the surface.¹⁹¹ Powder XRD, SEM, EDAX and UV/vis spectra were used to analyse films deposited at 400 °C which showed Ga₂O₃ along the gallium precursor inlet, In₂O₃ along the indium precursor inlet and a compositional gradient between the two (Fig. 25). This initial study showed the potential of the technique, with increasing indium content correlating to increased conductivity and changes in the band gap, consistent with previously reported band gaps of indium and gallium oxide.¹⁸¹ Recently, cAACVD has been used to deposit...
thin films of TiO$_2$-SnO$_2$ composite materials for photocatalytic applications.\textsuperscript{192}

A very recent study described the use of AACVD to investigate the effect of doping indium oxide with molybdenum or tin.\textsuperscript{184} Films were deposited at 450 °C, on glass substrates using methanol as a solvent from the precursors, [InCl$_3$·xH$_2$O] and [(NH$_4$)$_6$Mo$_7$O$_{24}$·4H$_2$O]. The undoped In$_2$O$_3$ films gave high charge carrier concentrations (1×10$^{20}$ cm$^{-3}$) and charge carrier mobilities (71 cm$^2$ V$^{-1}$ s$^{-1}$). However, upon doping with Mo charge carrier concentration and charge carrier mobility both increased significantly (4×10$^{20}$ cm$^{-3}$ and 119 cm$^2$ V$^{-1}$ s$^{-1}$) with no decrease in the transmittance. It was shown, using XPS, XAS and DFT calculations that Mo doping facilitated carrier mobility, in contrast there is much information published in the literature.\textsuperscript{197} There are a small range of precursors that have been used in the deposition of these materials, including tin alkoxides\textsuperscript{198,199} and β-diketonates,\textsuperscript{200,201} however only via techniques such as spin coating or spray pyrolysis,\textsuperscript{202} traditionally tin halides and NH$_x$F or HF are used. In addition, antimony is a popular dopant, which like F alters the electronic properties of the TCO materials produced.\textsuperscript{203,204} Commercially available precursors, such as tin chloride and antimony chloride have been used to deposit thin films via a range of techniques including sol–gel,\textsuperscript{208} thermal evaporation\textsuperscript{209} and spray pyrolysis.\textsuperscript{205,210}

Films were grown from a toluene solution of sn decane and ligand stabilised silicon nanocrystals onto glass substrates heated to 300 °C. Superior films gave sheet resistance of 400 Ω square$^{-1}$. UV/vis provided evidence for the incorporation of the silicon nanocrystals into the ITO and it was determined that processing temperatures greater than 300 °C result in oxidation and lead to an increase in sheet resistance.\textsuperscript{196}

It is well known that doping tin oxide can improve the conductivity of the resultant TCO material, but it can also enhance other properties, such as optical transmittance or stability. ITO is the most commercially used TCO material but it is followed by fluorine doped tin oxide, SnO$_2$:F (FTO) on which there is much information published in the literature.\textsuperscript{197} There are a small range of precursors that have been used in the deposition of these materials, including tin alkoxides\textsuperscript{198,199} and β-diketonates,\textsuperscript{200,201} however only via techniques such as spin coating or spray pyrolysis,\textsuperscript{202} traditionally tin halides and NH$_x$F or HF are used. In addition, antimony is a popular dopant, which like F alters the electronic properties of the TCO materials produced.\textsuperscript{203,204} Commercially available precursors, such as tin chloride and antimony chloride have been used to deposit thin films via a range of techniques including sol–gel,\textsuperscript{208} thermal evaporation\textsuperscript{209} and spray pyrolysis.\textsuperscript{205,210}

A recent study on the AACVD of FTO used a precursor, of the type [BuSnCl$_{x-y}$F$_y$]$_2$ formed \textit{in situ} by the halide exchange between \textit{n}-butyltin trichloride and ammonium fluoride.\textsuperscript{211} Since isolation of the precursor was not possible, evidence for the formation included XRD identification of the NH$_x$Cl side product and XPS of the precursor, indicating the formation of a Sn–F bond. The AACVD method lends itself to \textit{in situ} precursor synthesis, with the solution being immediately used to create an aerosol mist, thus removing the need for precursor isolation. This particular example highlighted the influence carrier solvent has on the functional properties of the materials.\textsuperscript{212} Varying the solvent had a significant effect on the film
microstructure and therefore the properties. The resultant films showed greater performance than industrial standards, something that has not been achieved using MOCVD techniques where solvent is not used, and therefore microstructure cannot be tuned. Owing to the significant differences observed when changing the solvent in the system, a thorough investigation into the deposition variables was conducted. Films were deposited on float glass, but a range of temperatures, solvents and carrier gases were investigated. It was shown that elevated temperatures, with air as the carrier gas and propan-2-ol as the solvent produced films with optical transparency, resistivity, charge carrier concentration and mobility better than that of the current industrial standard.\textsuperscript{213}

FTO films have also been deposited by AACVD using $n$-butyltin trichloride in methanol with varying amounts of trifluoroacetic acid at 350–550 °C.\textsuperscript{214} The films were produced using two methods for generating the aerosol: ultrasonic generation and collision type, which produce different size distributions of droplets (0.3 $\mu$m for collision type and 45 $\mu$m for ultrasonic) leading to different film characteristics. The films produced by the two AACVD methods were compared with those deposited via atmospheric pressure CVD from $n$-butyltin trichloride and trifluoroacetic acid at similar temperatures. It was found that films deposited using the small aerosol droplets (0.3 $\mu$m) gave films with better figures of merit than those using larger aerosol droplets (45 $\mu$m) or deposited from the same precursor set by atmospheric pressure CVD. This was attributed to the droplets generated by collision type being significantly smaller, resulting in shorter evaporation times (Fig. 27) and complete solute precipitation. The functional properties, including carrier mobility, charge-carrier density and surface morphology were found to be highly dependent on the deposition temperature using this AACVD technique with 450 °C resulting in films with optimum properties for low-emissivity coatings including a low visible haze (1.74%), high charge-carrier mobility (25 cm$^2$/Vs), high transmittance across the visible (80%) and high reflectance in the IR (80% at 2500 nm). In contrast, a deposition temperature of 500 °C produced FTO films ideal for use as top electrodes in photovoltaics with a low sheet resistance (3 $\Omega$ sq$^{-1}$).

Further attempts to improve the properties of FTO thin films were reported recently, with the incorporation of gold nanoparticles.\textsuperscript{215} A range of materials were reported in this comprehensive study, and most interestingly layered gold nanoparticles (AuNP) on FTO films exhibited blue colouration due to the surface plasmon resonance (SPR) of the AuNPs whilst maintaining high transparency in the visible, and electrical conductivity comparable to commercially available FTO (Fig. 28). This was the first report of layered TCO synthesis via AACVD with enhanced properties via production of homogenous AuNPs, the size of which was dependant on precursor concentration, with sheet resistances between 8–10 sq$^{-1}$.

Thin films of ZnO, SnO$_2$, and composite electrodes (ZnO/SnO$_2$ and ZnO/SnO$_2$/Zn$_2$SnO$_4$) have been deposited from precursor solutions of zinc acetate and tin(IV) chloride in methanol via AACVD.\textsuperscript{216} By changing the Zn:Sn mol% ratio in the precursor solution, single phase ZnO, SnO$_2$, and composite ZnO/SnO$_2$ and ZnO/SnO$_2$/Zn$_2$SnO$_4$ coatings were deposited on the FTO substrates at 380 °C. Controlling the Zn:Sn ratio in the precursor solution, resulted in films with a range of different morphologies, varying from compact electrodes to nanoparticle-, nanoplate-, and nanocolumn-type structures and the bandgap could be fine-tuned between that of ZnO (~3.31 eV) and that of SnO$_2$ (~3.55 eV). Other dopants for SnO$_2$ have also been investigated, including Mg in an attempt to achieve high conductivity and transparency.\textsuperscript{217,218}

The recent emergence of SnO$_2$ containing tin in its lower Sn(II) oxidation state, as a potential p-type material has generated much interest. A stannous ureid compound (Fig. 29) was synthesised by the addition of 2 equivalents of tert-butyl isocyanate to [Sn(NMe$_2$)$_2$].\textsuperscript{219} AACVD of the stannous ureid in toluene at 250–350 °C resulted in the deposition of tetragonal SnO films. Powder XRD showed that the only crystalline phase at temperatures $>$ 300 °C was tetragonal SnO with no evidence of disproportionation to Sn(O) and SnO$_2$. Raman spectroscopy
PEC solar cells must have a band gap such that they can absorb the maximum amount of the visible region of the spectrum whilst remaining photostable. PEC materials have the ability to use solar energy to split water into oxygen and hydrogen, and their efficiency is dependent on band energetics, bulk structure and surface properties. Hydrogen has also been produced by photocatalytic and photoelectrochemical routes. In order to improve efficiencies and cut costs attempts have been made to increase surface area and shorten charge transport pathways. Whilst nanostructured photocatalysts have come some way to meeting these criteria the larger surface area encourages defect recombination, hinders electron hole separation and reduces the photovoltage. Recent development in the field has seen a turn to CVD in order to deposit films with tuned microstructure. AACVD lends itself to the fabrication of these devices, since surface morphology can be easily controlled in this solution based technique to improve PEC performance, unlike other forms of CVD or film deposition. We direct the attention of the reader to these useful articles on PEC cells for more in depth detail.

5.1 Bismuth oxide based materials

Bismuth oxide (Bi₂O₃) exists as a number of polymorphs and as such the band gap is reported to lie within the range 2.29–3.31 eV. The low temperature α phase is stable with the other phases being metastable. It was the discovery that metastable δ-Bi₂O₃ had the highest oxide ion conductivity of any material that made it highly useful as a electrolyte, but it was its band gap that meant it was useful as a photocatalyst for degradation of pollutant dyes and water splitting. This versatile material has also found use in gas sensors, UV light photocatalyst, ferroelectric, multifilbic and superconducting oxides. In comparison to some other main group elements, such as gallium, there are only a limited number of bismuth precursors available, despite the same obstacles to film deposition including precursor volatility, high deposition temperatures and carbon contamination, being faced. Key attributes to successful precursors are the inclusion of at least one Bi–O bond, to overcome the energy barrier of formation in the CVD reactor, another is the use of sterically demanding ligands such that oligomerisation does not occur, affording volatile, soluble precursors. In general, precursor compounds of bismuth can be grouped into 3 sections; alkoxydes, β-diketonates and carbonylates. These precursors can be synthesised via a number of different routes, including alcoholysis of bismuth amides, e.g. $\text{[Bi(NMe₂)₃]}$ or the less air-sensitive bismuth silyl amide $\text{[Bi(N(SiMe₃))₃]}$, or metathesis reaction of bismuth halides and alkoxide salts. Due to the poor volatility, solubility and sensitivity of bismuth alkoxides, donor functionalised bismuth compounds were synthesised and their use in LPCVD reported. To further understand the potential of bismuth alkoxides and β-diketonates as CVD precursors TGA was carried out on a range of compounds. There are a number of reports of the deposition of thin films of Bi₂O₃ in the literature by a variety of techniques however this section will focus on recent developments in the AACVD of the material.
Bismuth β-diketonates have attracted attention as CVD precursors due to their increased stability to moisture; recently [Bi(dbm)\(_3\)]\(_2\) (dbm = dibenzoylmethane) was used as a precursor in AACVD of Bi\(_2\)O\(_3\) at 460–525 °C (Fig. 30). The films were synthesised via a co-deposition in order to dope with platinum nanoparticles using [H\(_2\)PtCl\(_6\)\(\cdot\)H\(_2\)O] as the Pt precursor. Films were found to consist of Pt–Bi\(_2\)O\(_3\), and the addition of Pt particles cause hydrogen evolution during photolysis of water, something that does not occur with Pt particles or Bi\(_2\)O\(_3\) alone. More recently the isolation of a bismuth carbamate [Bi(O\(_2\)CN\(iPr\))\(_3\)] (Fig. 31), a tetramer in the solid-state, was used to deposit Bi\(_2\)O\(_3\) via AACVD. It was shown in this study that δ-Bi\(_2\)O\(_3\) was initially deposited, which showed superior photocatalytic activity, and at longer deposition times a thick layer of β-Bi\(_2\)O\(_3\) nanowires grew on top, which proved to be less active (Fig. 32). Films were deposited from a precursor solution in hexane, on glass at temperatures ranging from 300–450 °C from 10–40 minutes. 244

5.2 Bismuth composite materials

As discussed above, there are a broad range of applications for bismuth oxide materials, as is true for its ternary and higher oxide materials. There has been much work over the last decade in the area of precursor synthesis which includes bismuth and other metals within the same molecule, to be used as single-source precursors. We direct the reader’s attention to a recent review in the area of bismuth precursor development for more detail237 and here focus on the upsurge in the last five years of AACVD in this area.

Bi\(_2\)S\(_3\) has a band gap of 1.7 eV with an absorption coefficient of 104–105 cm\(^{-1}\), making it an attractive material for PEC applications. 245 AACVD of bismuth selenide films was carried using at 475 °C, with the precursor, [Bi[(Se\(tPr\))\(_2\)]\(_3\)] dissolved in THF (vide supra). 108 The resulting crystalline Bi\(_2\)Se\(_3\) films showed preferred orientation along the (006) direction. In the same report, [Bi[(SP\(_tPr\))\(_2\)]\(_3\)] (R = iPr or Ph) was used to deposit thin films of Bi\(_2\)S\(_3\) at 425–475 °C, and despite poor morphology and crystallinity the band gap of the material was calculated to be 1.32 eV, in excellent agreement with the literature value of 1.3 eV. This study showed that AACVD was an excellent tool to control phase and morphology of the material (Fig. 33). 116 AACVD was used again to deposit nanoparticles and tubes of Bi\(_2\)S\(_3\) onto FTO coated glass. By varying the solvent used the surface morphology could be controlled; precursor solutions of [Bi(S\(_2\)CNEt\(_2\))\(_3\)]\(_2\) in chloroform or dichloromethane yielded films of well defined nanotubes (diameter ~ 40 nm). Alternatively films deposited from chloroform/toluene mixtures gave compacted nanostructured morphology. Films were deposited at temperatures between 350–450 °C, and the band gap of the materials was calculated to be 1.85 and 1.8 eV respectively. PEC testing showed an excellent response, with photocurrent densities of 1.9 mA cm\(^{-2}\) and 1.0 mA cm\(^{-2}\) at 0.23 V versus Ag/AgCl/3 M KCl, respectively. 114
Thin films of BiFeO₃ were synthesised via AACVD for the first time using the known heterometallic precursor [CpFe(CO)₂BiCl₂]. Films were deposited on glass from a precursor solution in THF at 300 °C, resulting in dark orange adherent films. The band gap was calculated to lie between 2.0 and 2.2 eV and photocatalytic testing showed that the material was superior to TiO₂, industrial standards when irradiated under UVA (365 nm) with an average O₂ yield of 24.4% which represents a ten-fold increase over optimised B-doped TiO₂ films.

Bismuth titanate (Bi₂Ti₂O₇) thin films have been prepared for the first time via AACVD using bismuth nitrate pentahydrate in acetylacetone and titanium isopropoxide in methanol. The crystallinity of the films was improved by post annealing (Fig. 34). Films were deposited at 600 °C on FTO substrates, and then annealed at 600 °C for 12 hours in order to afford phase pure Bi₂Ti₂O₇ photoelectrodes. The photocurrent density was reported as 1.8 µA cm⁻¹ at 0.23 V versus Ag|AgCl, with a direct bandgap of 2.74 eV, making it potentially better than TiO₂, since it absorbs a greater proportion of the solar spectrum and exhibits less recombination. Thin films of phase pure bismuth vanadate (BiVO₄) photoelectrodes have also been prepared by AACVD on FTO glass substrates. Bismuth vanadate has a band gap of 2.4 eV in the monoclinic scheelite phase and is considered one of the most promising anodic semiconductor materials for PEC, not least because of its stability in pH neutral conditions. SEM images of the BiVO₄ films deposited via AACVD from bismuth nitrate pentahydrate in acetyl acetone and vanadyl acetyl acetonate in methanol at 500 °C, showed that the film were porous (Fig. 35). This porosity results in the films having a high interfacial area allowing for a reduction in electron–hole recombination.

5.3 Other PEC materials

A selection of recently deposited PEC main group materials that utilise the AACVD technique in their fabrication are briefly summarised below.

Zinc sulfide films were deposited on FTO coated glass at temperatures between 375–475 °C from solutions of the novel precursors [Zn(S₂CNRR₃)₂(py)] (where Cy = cyclohexyl, py = pyridine) and [Zn(S₂CN(CH₂Ph)(Me))₂(py)] in toluene (vide supra). The ZnS thin film electrode prepared showed promising properties for solar energy conversion and optoelectronic applications. Band gap energies of 3.36 and 3.40 eV were estimated respectively, with PEC studies showing that the films were photoactive under anodic bias conditions. It was shown that films deposited at lower temperatures (375 °C) consisted of cauliflower like structure, which was not present in films deposited at higher temperature (425 °C) (Fig. 36). 39

Thin films of indium sulfide were deposited via AACVD of novel compounds of the type, [In(S,S,NRR′)₃∙n(py)]. Films of β-In₃S₄ were deposited on FTO coated glass substrates at 300, 350 and 400 °C, with SEM images showing that varying temperature of deposition or ligand (R, R’ = ‘Pr, n = 1.5, NRR’ = pip, n = 0.5, R = Bz, R’ = Me, n = 0) had an affect on the morphology of the films deposited (vide supra). The band gap of the films deposited was calculated to be ~2.2 eV with the PEC properties yielding photocurrent densities of 1.25 and 0.65 mA cm⁻² at 0.23 V versus Ag|AgCl for the In₃S₄ films deposited at 400 °C and 350 °C respectively (Fig. 37). This was the highest photocurrent...
and the films were prepared using the precursor $[\text{In(S}_2\text{CNiPr}_2\text{)}_3\text{.15(py)}]$. The higher response compared to the films deposited from the other precursors was thought to be due to the uniform structure of the multi-shaped $\beta$-$\text{In}_2\text{S}_3$ crystallites in the film and better interconnections of particles in the film.

6 Main group gas sensing materials

Semiconducting metal oxides have been widely used in gas sensor devices since the absorption and desorption of a gas on the surface of a metal oxide changes the conductivity of the material. The sensitivity of the surface to a gas can be as low as parts per billion and ideally the metal oxide semiconductor sensor should have a large surface area in order to adsorb as much of the target analyte as possible on the surface to give a measurable response at such low concentrations. Gas sensor development have particularly focussed on the detection of species, such as CO$_2$, CO, SO$_2$, O$_3$, NH$_3$, NO, and H$_2$, due to atmospheric pollution, toxicity and that they can be found at high levels in some environments. Tin dioxide is used commercially as a gas sensor. However, the search for new gas sensing materials is of great interest as SnO$_2$ suffers from cross sensitivity issues, humidity interference and baseline drift. Main group materials that have been investigated for gas sensors applications include gallium oxide, indium oxide and tin dioxide. Fabrication methods need to be low cost, scalable and lead to films with appropriate morphology to achieve the required gas sensing response. Gas sensors have been widely reviewed including a recent review on the AACVD of some gas-sensitive nanomaterials. The following sections provide an up-to-date overview of main group oxide films grown by AACVD that have been investigated as gas sensors.

6.1 Gallium and indium oxide based materials

Gallium oxide (Ga$_2$O$_3$) is an ideal material for application as a thin film gas sensor as the function of the sensor can be switched with temperature. At temperatures below 900 °C, gallium oxide thin film operates as a surface-control-type sensor to reducing gases, such as CO and ethanol. However, at temperatures above 900 °C the conductivity changes depend on the concentration of oxygen, therefore oxygen concentration can be monitored. Oxygen gas sensors have practical use in monitoring and controlling oxygen concentrations in waste gases, chemical processes and exhaust gases of automobiles. Thin films of Ga$_2$O$_3$ have been deposited from the in situ AACVD reaction of $[\text{Ga(NMe}_2\text{)}_3\text{]}$ and ROH ($R = \text{CH}_2\text{CH}_2\text{NMe}_2$, $\text{CH}($$\text{CH}_3\text{)}\text{CH}_2\text{NMe}_2$, $\text{CH}_2\text{CH}_2\text{OME}$ and $\text{C}($$\text{CH}_3\text{)}_2\text{CH}_2\text{OME}$) in toluene at 550 °C (vide supra). Transparent and unreflective films of gallium oxide were deposited from the reaction which generated gallium tris(alkoxides) in situ. The films were deposited on gas sensor substrates and an n-type response to ethanol at a range of temperatures was measured. Gas response was measured as the ratio between $R$ (the resistance when exposed to ethanol) and $R_0$ (the point immediately preceding the introduction of ethanol). The gas response was rapid and the level did not vary much throughout the experimental process. The greatest response to a gas concentration of 100 ppm of ethanol was $R/R_0$ at 1.13. Screen-printed sensors showed a greater response ($R/R_0 = 2.12$), which is likely due to the thinner films produced by AACVD and differences in film morphology. However, CVD sensors have been shown to give a maximum response to oxidizing or reducing gases at significantly lower temperature (100–250 °C) than screen-printed sensors.

Indium oxide (In$_2$O$_3$) is used in industrial and technological applications, such as toxic/dangerous gas detection with particular sensitivity to reducing gases, such as ethanol and ammonia and oxidising gases such as O$_2$. Thin films of In$_2$O$_3$ and In$_2$O$_3$:M (M = Ti or Ta) have been deposited on glass substrates via AACVD at 450 °C from the in situ reaction of InMe$_3$ and HOCH$_2$CH$_2$NMe$_2$ and the addition of a transition metal alkoxide precursor (synthesised from the in situ reaction of $[\text{M(NMe}_2\text{)}_3\text{]}$ [M = Ti, n = 4; M = Ta, n = 5] and HOCH$_2$CH$_2$NMe$_2$) to produce the doped films, as shown in Scheme 5. The In$_2$O$_3$:M films were found to contain 6.5 and 2.3 at% of Ti and Ta, respectively. Films deposited on gas sensing substrates were tested for their sensitivity to increasing concentrations of both reducing and oxidizing gases (ethanol, carbon monoxide, ammonia, NO$_2$). The tantalum doped indium oxide films (In$_2$O$_3$:Ta) showed an enhanced response, compared to In$_2$O$_3$,
to both the reducing and oxidising gases with considerable selectivity to ethanol observed where the greatest gas response ($R/R_0$) was 16.95 to 100 ppm ethanol (Fig. 37). The greater response is likely due to the reduced crystallite size for the $\text{In}_2\text{O}_3$:Ta films in comparison to the undoped indium oxide films resulting in a more reactive surface and an increased surface area to volume ratio.

### 6.2 Tin oxide based materials

Tin dioxide ($\text{SnO}_2$) is efficiently employed in gas sensing applications and a comprehensive review has been reported recently which details the role of morphology and performance of this materials.\(^{257}\) Since the first commercial $\text{SnO}_2$ gas sensor was successfully produced in 1968 this type of gas sensor has been widely used in a range of applications including the automobile industry and environmental monitoring. A number of techniques have been used to prepare $\text{SnO}_2$ thin films such as the sol–gel route, evaporation and sputtering.\(^{242}\) AACVD has been used to deposit $\text{SnO}_2$ thin films and their gas sensing response has been investigated.

AACVD of $[\text{Sn}(18\text{-Cr}-6)\text{Cl}_4]$ and $[\text{SnCl}_4(\text{H}_2\text{O})_2](18\text{-Cr}-6)$ in which the crown ether acts as a multitandate macrocyclic ligand which prevents premature hydrolysis, was carried out in a methanol/toluene mixture at 250–500 °C.\(^{258}\) The gas sensing properties of the resulting films were tested to 10 ppm NO$_2$ in air at operating temperatures of 200, 250 and 300 °C. The precursor used was found to affect the $\text{SnO}_2$ film produced with those obtained from $[\text{Sn}(18\text{-Cr}-6)\text{Cl}_4]$ having orientated particles of $\text{SnO}_2$, a shorter recovery time and higher response to 10 ppm NO$_2$ in air compared to $[\text{SnCl}_4(\text{H}_2\text{O})_2]_{18\text{-Cr}-6}$. This is most likely a result of the different morphology of the films which possibly relates to the coordination of the Sn atoms where in $[\text{Sn}(18\text{-Cr}-6)\text{Cl}_4]$ the crown ether is directly coordinated to the tin atom whereas in $[\text{SnCl}_4(\text{H}_2\text{O})_2](18\text{-Cr}-6)$ coordination with tin occurs through water molecules. The sensor response to NO$_2$ was found to increase as the operating temperature increased.

AACVD of $\text{SnCl}_4\cdot2\text{H}_2\text{O}$ in absolute ethyl alcohol at 400 °C followed by annealing at 600 °C resulted in the formation of pure $\text{SnO}_2$ films.\(^{259}\) By the addition of Cu(OAc)$_2$ to the solution Cu-doped $\text{SnO}_2$ films were also deposited. The films were tested to 50 ppm H$_2$S at 25 °C. The Cu-doped $\text{SnO}_2$ films showed a response of 85–50 ppm H$_2$S gas and complete recovery between testing cycles at room temperature was observed. No response was observed to CO and CH$_4$ and so some selectivity to H$_2$S was found.

### 7 Conclusions

As described above, CVD is an attractive process for the fabrication of a wide range of materials, with use in a host of devices from gas sensors all the way to solar cells and window coatings. The main focus of this review has been the use of AACVD to deposit main group materials. Until recently, AACVD has been limited by ‘scalability’, despite its high mass transport rate but it is now seeing fast expansion, with the advent of scale-up projects in industrial plants. The benefits of this variant of CVD much outweigh its limitations; central to the process is its reliability on solubility rather than volatility, which vastly extends the range of precursors available, furthermore the technique lends itself to better morphological control. Films can be deposited on glass, steel, alumina, silica and on a host of other surfaces and uniform films with excellent adhesion can be achieved by this technique.

AACVD has been shown to be an adaptable technique, it lends itself well to combinatorial AACVD, which provides a rapid route to investigate the effect of a dopant on the functional properties of a wide range of materials. As it is a solution-based technique, films with a range of compositions can be deposited, even if volatile precursors are not available. Recently, a new variant of AACVD, namely time resolved (tr)AACVD, has been described which allows the growth of a composite thin film to be studied over time.\(^{260}\) This method allowed the functional properties of the films to be tracked as a function of time. The production of representative samples at different times during the deposition sequence permitted changes in surface morphology, crystal structure and relative concentrations of atoms, to be linked to changes in functional properties. Other recent novel variants of AACVD include a seeding/overlay method using AACVD and atmospheric pressure CVD techniques respectively, which was shown very recently to be an excellent method to direct the growth and affect the morphology of highly transparent, conducting FTO films.\(^{261}\)

In recent years particular attention has been drawn to the design of precursors and their ligands in order to improve the properties of the resultant films. Ligands were designed to facilitate cleaner decomposition to reduce contamination, and lower cost and to increase volatility and/or solubility, however air sensitivity and shelf life can be problematic. With the expanding field of flexible electronics, low temperature routes are sought and AACVD is an ideal technique to achieve low temperature depositions. AACVD has been shown to be a versatile technique, allowing for the deposition of a range of materials. For example, phase pure, methyl-ammonium lead iodide thin films on large glass substrates can be deposited using AACVD, which opens up a route to efficient scale up of hybrid perovskite film growth towards industrial application.\(^{262}\) AACVD has also been shown to be an excellent technique for the deposition of doped films, ternary and composite materials, for
example PbO–TiO₂ composite films and Cu₂ZnSnSe₄ (CZTSe) films. A recent review on the AACVD of organic–inorganic nanocomposite coatings, using cold plasma has been reported.

An AACVD technique has also been used recently for the synthesis of large-area, mm-thick carpets of vertically aligned multi-wall carbon nanotubes (MWNTs).

The morphological control available through use of AACVD could be of key importance to applications in gas sensing, photocatalysis and PEC devices. Moreover, chalcogenide materials, for example kesteric materials, such as CZTSe, are of key interest for applications in polycrystalline photovoltaic solar cells. These materials are challenging to grow in thin film form in sufficient quality and AACVD has been shown to be a viable CVD method for their deposition. These areas are all ripe for further development and discovery.

Solution based techniques to TCO films are of key interest in order to simplify synthetic procedures and lower the cost whilst still delivering a high performance. AACVD has already been shown to be an excellent technique for the deposition of TCO films with figures of merit significantly beyond current commercial products. This is an area open for further research both within main group materials and other materials such as Nb-doped TiO₂ for the preparation of indium-free TCOs and the development of low-temperature routes. Furthermore, with careful design of the precursor in combination with the use of AACVD, p-type TCOs can be deposited which represents another area worthy of further research.

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